IPC ASSOCIATION ELECTRONICS	© Copyright 2005. I	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			nder both Tile	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ıs Materia	ials and Mfg Information			
upplier	Information						<u> </u>								
ompany r	name*	Company unique ID			J	Unique ID Authority					Response Date*				
nsemi												2025-05-08			
Contact Na	nme	Title - Contact			I	Phone - Contact*					Email - Contact*				
Product-E	nv-Stewards	Product Enviro Compliance			1	NA					Product-Env-Stewards@onsemi.com				
uthorized	Representative*	Title - Representative			I	Phone - Representative*				Email - Representative*					
Product-E	nv-Stewards	Product Enviro Compliance			1	NA					Product-Env-Stewards@onsemi.com				
	Requester Item Number Mfr Item		n Number Mfr Item Name			Effective Date	e Vei	Version Manufacturing Site		g Site	W	eight*	UOM	Unit Type	
		NCP1342ANDCDAD High Frequency Qua 1R2G Controller		uasi-Resonant Fl	yback	2025-05-08	TH6			74	.53	mg	Each		
Ianufac	turing Proccess Informa	tion													
· ·	Terminal Plating / Grid Array M	Γerminal Base Alloy J-STD-020 MSL		-STD-020 MSL R	Rating	Peak Process Body Temperature Max Time		at Peak T	Γemperatu:	e Numb	er of Reflow Cyc	eles			
I	Matte Tin (Sn) - annealed		CU Alloy 1			260 C 30			seconds 3						
omments					•									•	
vel 1 - ma	ximum time at peak temperatu	ure during so	ldering is 10-3	0 seconds											
or more ii	nformation regarding material	composition	please refer to	page 3											<del>-</del>

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledges and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Itability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's S											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.82	mg	Supplier	Silicon (Si)	7440-21-3		1.82	mg
Die Attach Epoxy	0.39	mg		Epoxy resin	proprietary data		0.2535	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		0.1365	mg
Lead Frame	21.32		Supplier	Silver (Ag)	7440-22-4		0.3624	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0256	mg
			Supplier	Iron (Fe)	7439-89-6		0.501	mg
			Supplier	Copper (Cu)	7440-50-8		20.4246	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0064	mg
Mold Compound-Black	49.48			Epoxy resin	proprietary data		2.474	mg
			Supplier	Phenolic Resin	Proprietary Data		0.9896	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		1.237	mg
			Supplier	Carbon Black (C)	1333-86-4		0.2474	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		44.532	mg
Plating	1.37	mg	Supplier	Tin (Sn)	7440-31-5		1.37	mg
Wire Bond - Au	0.15	mg	Supplier	Gold (Au)	7440-57-5		0.15	mg